

ABSOLUTE MAXIMUM RATINGS

(Note 1)

Supply Voltage (V_{CC})	6V
Input Voltage	
Driver	$-0.3V$ to $V_{CC} + 0.3V$
Receiver	$-25V$ to $25V$
Driver/Receiver Enable Pin	$-0.3V$ to $V_{CC} + 0.3V$
Output Voltage	
Driver	$-25V$ to $25V$
Receiver	$-0.3V$ to $V_{CC} + 0.3V$
Short-Circuit Duration	
V^+	30 sec
V^-	30 sec
Driver Output	Indefinite
Receiver Output	Indefinite
Operating Temperature Range	
LTC1348C	$0^{\circ}C$ to $70^{\circ}C$
LTC1348I	$-40^{\circ}C$ to $85^{\circ}C$
Storage Temperature Range	$-65^{\circ}C$ to $150^{\circ}C$
Lead Temperature (Soldering, 10 sec)	$300^{\circ}C$

PACKAGE/ORDER INFORMATION

<p>TOP VIEW</p> <p>G PACKAGE 28-LEAD PLASTIC SSOP</p> <p>SW PACKAGE 28-LEAD PLASTIC SO</p> <p>$T_{JMAX} = 125^{\circ}C$, $\theta_{JA} = 96^{\circ}C/W$ (G) $T_{JMAX} = 125^{\circ}C$, $\theta_{JA} = 85^{\circ}C/W$ (SW)</p>	ORDER PART NUMBER
	LTC1348CG LTC1348CSW LTC1348IG LTC1348ISW

Consult factory for Military grade parts.

DC ELECTRICAL CHARACTERISTICS

 $V_{CC} = 3V$ to $5.5V$, $C1$ to $C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Any Driver					
Output Voltage Swing	$V_{CC} = 3.3V$, 3k to GND	5.0	6.2		V
	Positive	•			
	Negative	•			
Logic Input Voltage Level	Input Low Level ($V_{OUT} = \text{High}$)	•		0.8	V
	Input High Level ($V_{OUT} = \text{Low}$), $V_{CC} = 3.3V$	•	2.0		V
	Input High Level ($V_{OUT} = \text{Low}$), $V_{CC} = 5V$	•	2.4		V
Logic Input Current	$V_{IN} = V_{CC}$	•		5	μA
	$V_{IN} = 0V$	•	-5	-35	μA
Output Short-Circuit Current	$V_{OUT} = 0V$		± 12		mA
Output Leakage Current	Shutdown (Note 3) or Receiver Alive Mode (Note 4), $V_{OUT} = \pm 20V$	•	± 10	± 500	μA
Any Receiver					
Input Voltage Thresholds	Input Threshold (Receiver Alive Mode)	0.8	1.5	2.4	V
	Input Low Threshold (Normal Mode)	0.8	1.3		V
	Input High Threshold (Normal Mode)		1.7	2.4	V
Hysteresis	Normal Mode		0.3		V
Input Resistance	$V_{IN} = \pm 10V$		3	5	k Ω
Output Voltage	Output Low, $I_{OUT} = -1.6mA$	•		0.2	V
	Output High, $I_{OUT} = 160\mu A$	•	$V_{CC} - 0.6V$	0.4	V
Output Short-Circuit Current	Sinking Current, $V_{OUT} = V_{CC}$		-3	-20	mA
Output Leakage Current	Shutdown (Note 3), $0V \leq V_{OUT} \leq V_{CC}$	•	1	10	μA

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3V$ to $5.5V$, $C1$ to $C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Power Supply Generator					
V^+ Output Voltage	$I_{OUT} = 0mA$		8.0		V
	$I_{OUT} = 8mA$		7.5		V
V^- Output Voltage	$I_{OUT} = 0mA$		-8.0		V
	$I_{OUT} = -8mA$		-7.0		V
Supply Rise Time	Shutdown to Turn-On		0.2		ms
Power Supply					
V_{CC} Supply Current	No Load (Note 2) $V_{CC} = 3.3V$	●	0.6	2.0	mA
	No Load (Note 2) $V_{CC} = 5V$	●	0.8	2.5	mA
	Receiver Alive Mode (Note 4) $V_{CC} = 3.3V$ or $5V$	●	15	30	μA
Supply Leakage Current (V_{CC})	Shutdown (Note 3)	●	0.2	10	μA
Driver/Receiver Enable Threshold Low		●		0.8	V
Driver/Receiver Enable Threshold High	$V_{CC} = 3.3V$	●	2.0		V
Driver/Receiver Enable Threshold High	$V_{CC} = 5V$	●	2.4		V

AC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3V$ to $5.5V$, $C1$ to $C4 = 0.1\mu F$, unless otherwise noted.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Data Rate	$R_L = 3k$, $C_L = 1000pF$, One Driver Switching	120	250		kbps
Slew Rate	$V_{CC} = 5V$, $R_L = 3k$, $C_L = 51pF$		8	30	V/ μs
	$V_{CC} = 3.3V$, $R_L = 3k$, $C_L = 2500pF$	3			V/ μs
Driver Propagation Delay (TTL to RS232)	t_{HLD} (Figure 1)	●	2.5	4	μs
	t_{LHD} (Figure 1)	●	2.5	4	μs
Receiver Propagation Delay (RS232 to TTL)	t_{HLR} (Figure 2) (Normal Mode)	●	0.3	1	μs
	t_{LHR} (Figure 2) (Normal Mode)	●	0.2	1	μs
	t_{HLR} (Figure 2) (Receiver Alive Mode)	●	1.0	4	μs
	t_{LHR} (Figure 2) (Receiver Alive Mode)	●	0.2	4	μs

The ● denotes specifications which apply over the full operating temperature range ($0^\circ C \leq T_A \leq 70^\circ C$ for Commercial grade and $-40^\circ C \leq T_A \leq 85^\circ C$ for Industrial grade).

Note 1: Absolute Maximum Ratings are those values beyond which the life of the device may be impaired.

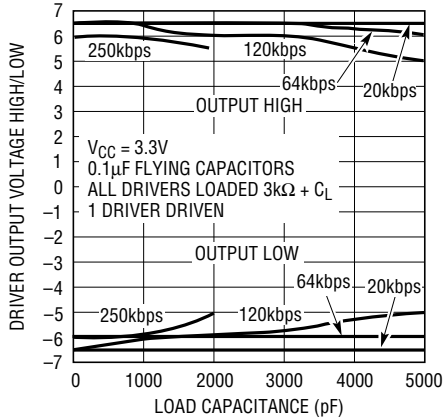
Note 2: Supply current is measured with driver and receiver outputs unloaded. The V_{DREN} and $V_{RXEN} = V_{CC}$.

Note 3: Supply current measurement in Shutdown is performed with V_{DREN} and $V_{RXEN} = 0V$.

Note 4: Supply current measurement in Receiver Alive mode is performed with $V_{DREN} = 0V$ and $V_{RXEN} = V_{CC}$.

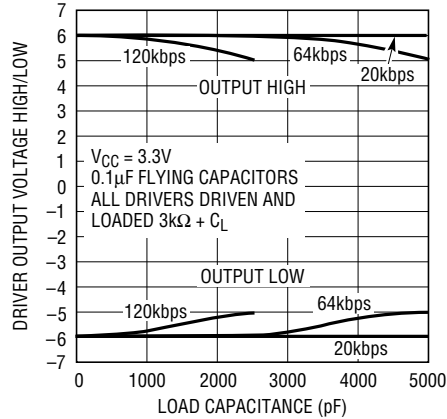
TYPICAL PERFORMANCE CHARACTERISTICS

Driver Output Voltage High/Low vs Load Capacitance (C_L)



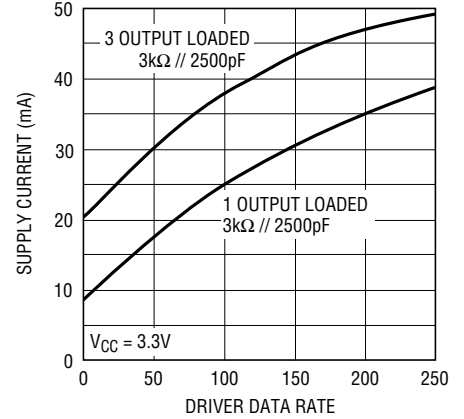
LTC1348 G01

Driver Output Voltage High/Low vs Load Capacitance (C_L)



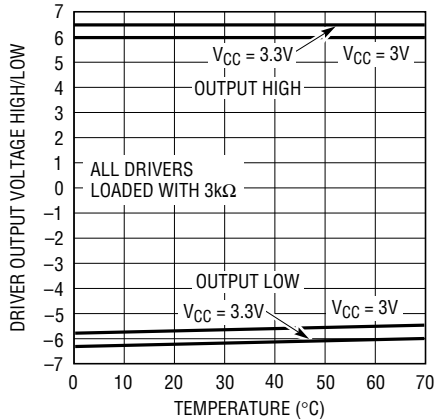
LTC1348 G02

Supply Current vs Driver Data Rate



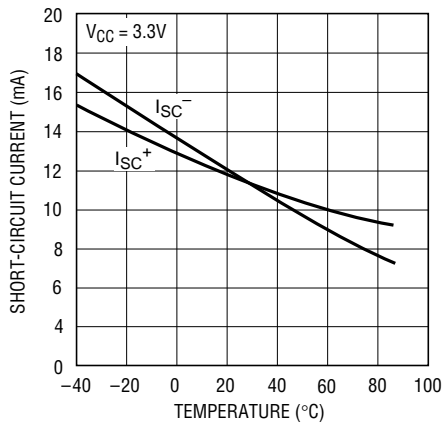
LTC1348 G03

Driver Output Voltage High/Low vs Temperature ($^{\circ}C$)



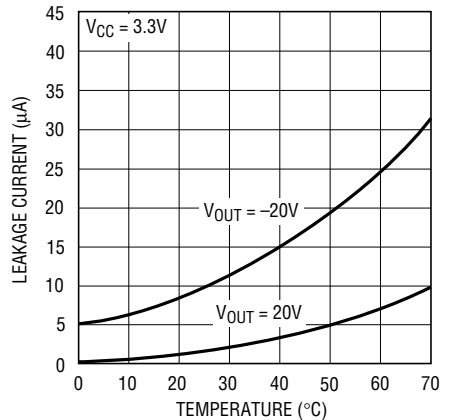
LTC1348 G04

Driver Short-Circuit Current vs Temperature ($^{\circ}C$)



LTC1348 G05

Driver Leakage in SHUTDOWN vs Temperature ($^{\circ}C$)

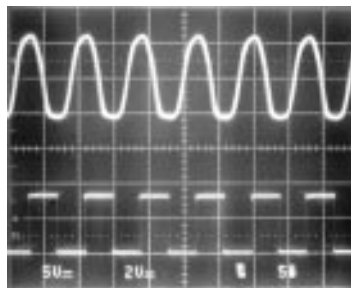


LTC1348 G06

**With $V_{CC} = 3.3V$
All Driver Outputs Loaded with
 $3k\Omega$, 1000pF. 1 Driven at 250kbps**

DRIVEN DRIVER
OUTPUT

DRIVER
INPUT



LTC1348 G07

PIN FUNCTIONS

V_{CC}: 3V to 5.5V Input Supply Pin. This pin should be decoupled with a 0.1μF ceramic capacitor.

GND: Ground Pin.

RXEN: TTL/CMOS Compatible Enable Pin. Refer to Table 1 for its functional description.

DREN: TTL/CMOS Compatible Enable Pin. Refer to Table 1 for its functional description.

V⁺: Positive Supply Output (RS232 Drivers). This pin requires an external capacitor $C = 0.1\mu\text{F}$ for charge storage. The capacitor may be tied to ground or V_{CC}. With multiple devices, the V⁺ and V⁻ pins may be paralleled into common capacitors. For large numbers of devices, increasing the size of the shared common storage capacitors is recommended to reduce ripple.

V⁻: Negative Supply Output (RS232 Drivers). This pin requires an external capacitor $C = 0.1\mu\text{F}$ for charge storage.

C1⁺, C1⁻, C2⁺, C2⁻, C3⁺, C3⁻: Commutating Capacitor Inputs. These pins require three external capacitors $C = 0.1\mu\text{F}$: one from C1⁺ to C1⁻, another from C2⁺ to C2⁻ and another from C3⁺ to C3⁻. To maintain charge pump

efficiency, the capacitor's effective series resistance should be less than 1Ω. Ceramic capacitors are recommended.

DR IN: RS232 Driver Input Pins. Inputs are TTL/CMOS compatible. The inputs of unused drivers can be left unconnected since 300k input pull-up resistors to V_{CC} are included on chip. To minimize power consumption, the internal driver pull-up resistors are disconnected from V_{CC} in the Shutdown or Receiver Alive mode.

DR OUT: Driver Outputs at RS232 Voltage Levels. Outputs are in a high impedance state when in the Shutdown, Receiver Alive mode or V_{CC} = 0V. The driver outputs are protected against ESD to ±10kV for human body model discharges.

RX IN: Receiver Inputs. These pins can be forced to ±25V without damage. The receiver inputs are protected against ESD to ±10kV for human body model discharges. Each receiver provides 0.4V of hysteresis for noise immunity. In Receiver Alive mode all receivers have no hysteresis.

RX OUT: Receiver Outputs with TTL/CMOS Voltage Levels. Outputs are in a high impedance state when in the Shutdown or Receiver Disable mode to allow data line sharing.

Table 1. Functional Description

MODE	RX ENABLE	DR ENABLE	DRIVERS	RECEIVERS	I _{CC} TYP
Shutdown	0	0	All Drivers Shutdown. All Driver Outputs Assume High Impedance. All Driver Pull-Up Resistors Disconnect From V _{CC} .	All Receivers Shutdown. All Receiver Outputs Assume High Impedance.	0.2μA
Receiver Disable	0	1	All Drivers Alive.	All Receiver Outputs in Three-State.	600μA at 3.3V, 800μA at 5V
Receiver Alive	1	0	All Drivers Shutdown. All Driver Outputs in Three-State. All Driver Pull-Up Resistors Disconnect From V _{CC} .	All Receivers Alive.	15μA
Normal	1	1	All Drivers Alive.	All Receivers Alive.	600μA at 3.3V, 800μA at 5V

SWITCHING TIME WAVEFORMS

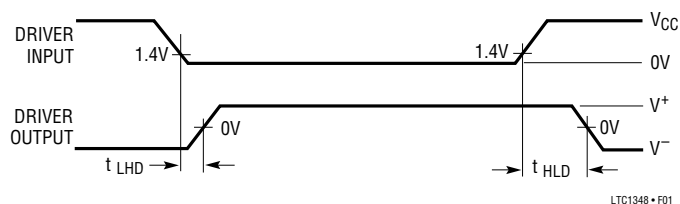


Figure 1. Driver Propagation Delay Timing

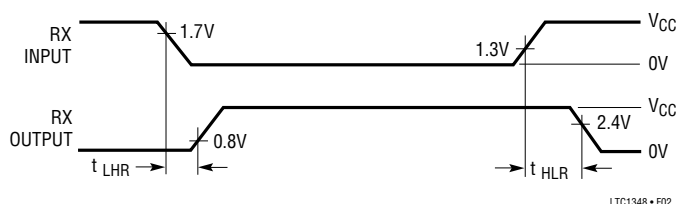


Figure 2. Receiver Propagation Delay Timing

TEST CIRCUITS

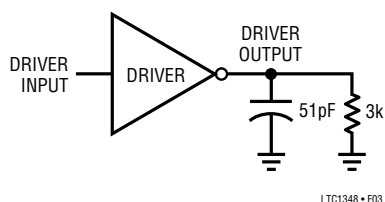


Figure 3. Driver Timing Test Load

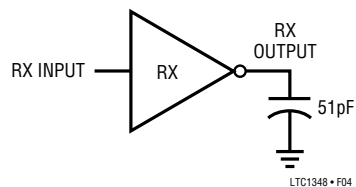
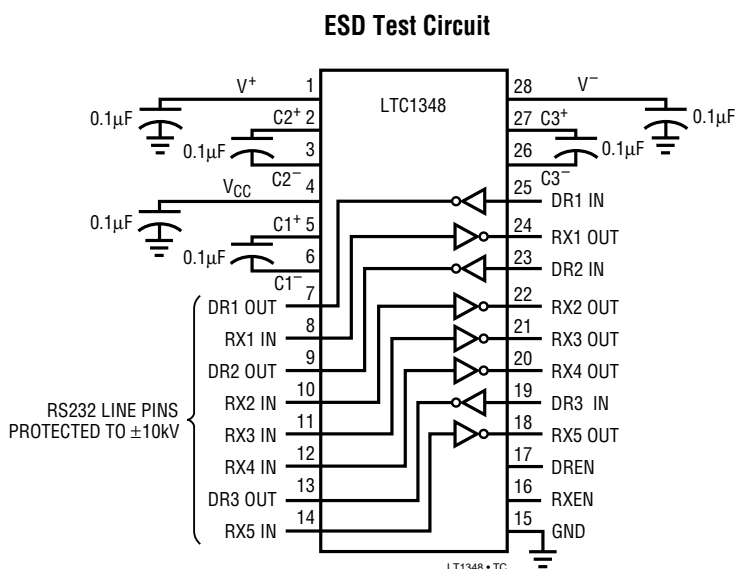


Figure 4. Receiver Timing Test Load



APPLICATIONS INFORMATION

Power Supply

The LTC1348 includes an onboard voltage-tripling charge pump capable of generating $\pm 8V$ from a single 3.3V supply. This allows the LTC1348 drivers to provide guaranteed $\pm 5V$ RS232-compliant voltage levels with a 3.3V supply. With all outputs loaded with $3k\Omega$, the LTC1348 can typically swing $\pm 5V$ with voltages as low as 2.85V. It will meet the $\pm 3.7V$ EIA562 levels with supply voltages as

low as 2.2V. The charge pump requires three external flying capacitors to operate; $0.1\mu F$ ceramic capacitors are adequate for most applications. For applications requiring extremely high data rates or abnormally heavy output loads, $0.33\mu F$ flying capacitors are recommended. Bypass and output capacitor values should match those of the flying capacitors and all capacitors should be mounted as close to the package as possible.

APPLICATIONS INFORMATION

High Data Rates

The LTC1348 maintains true RS232 $\pm 5V$ minimum driver output even at high data rates. Figure 5 shows a test circuit with 2m wires connecting the two test chips. Both chips are run from 3.3V supplies. Figure 6 shows the typical line waveforms with all three drivers, loaded with 1000pF and 3k Ω , toggling simultaneously at 120kbaud. Figure 7 shows

the same circuit with a single 1000pF/3k Ω loaded driver driven at 250kbaud, and the other two drivers loaded but not toggling. This closely approximates the actual behavior of an RS232 serial port, with only one driver (TX) driven at high speed and the other two drivers (RTS and DTR) driven at a relatively low data rate or at DC. Under the same conditions, the LTC1348 can go as fast as 350kbaud and still meet EIA562 ($\pm 3.7V$) minimum driver output levels.

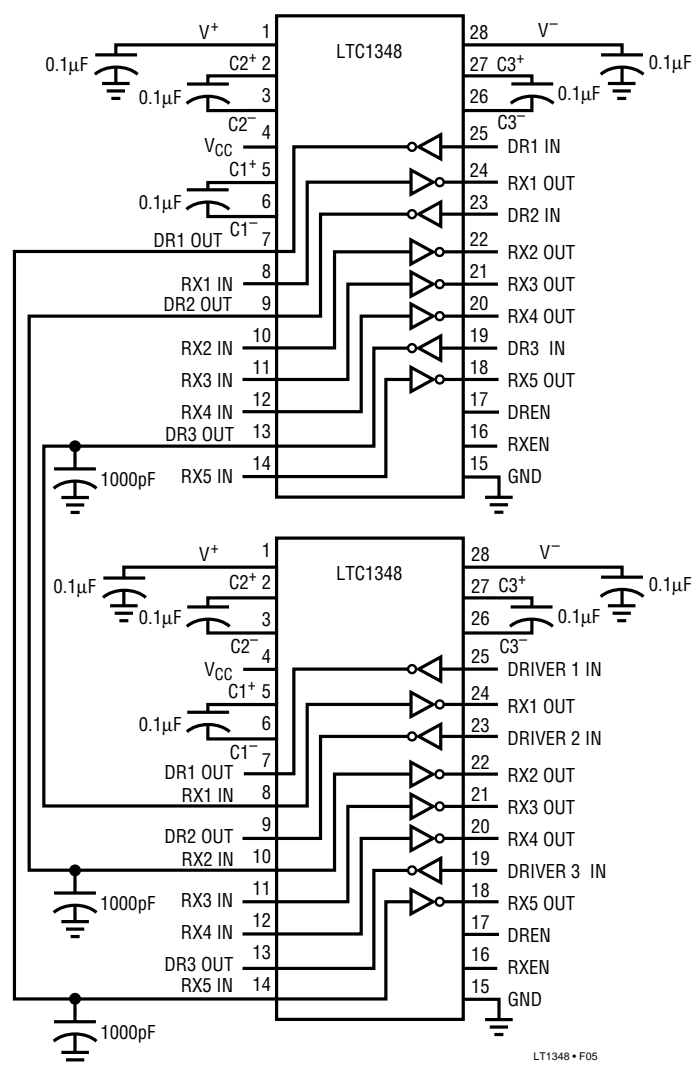


Figure 5. Data Rate Evaluation Circuit

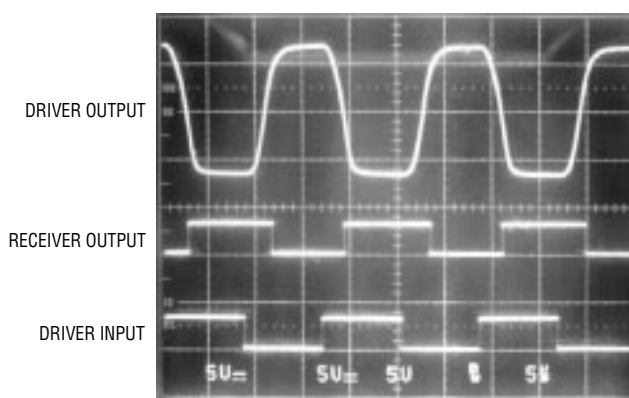


Figure 6. Driver Test Result at 120kbps

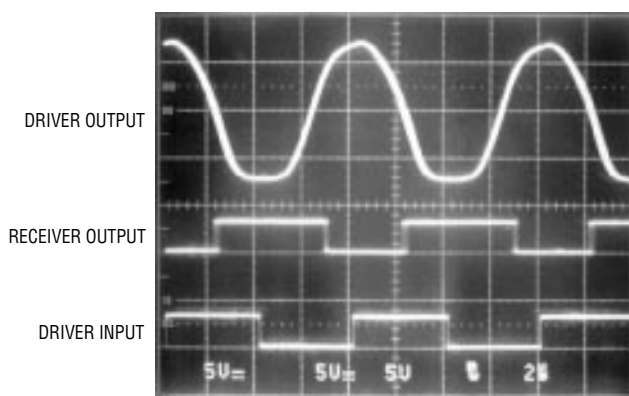
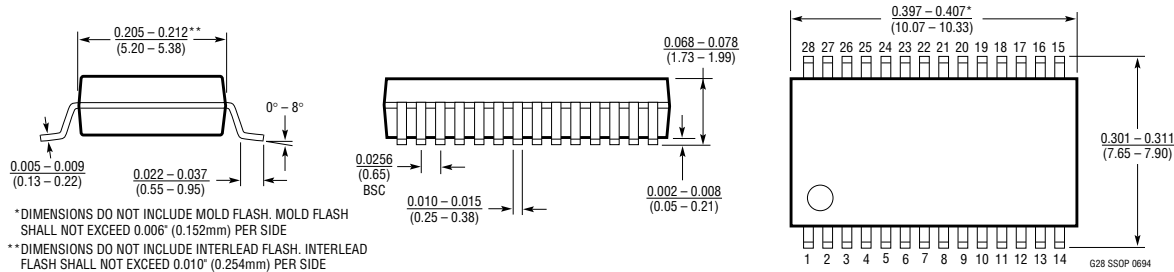


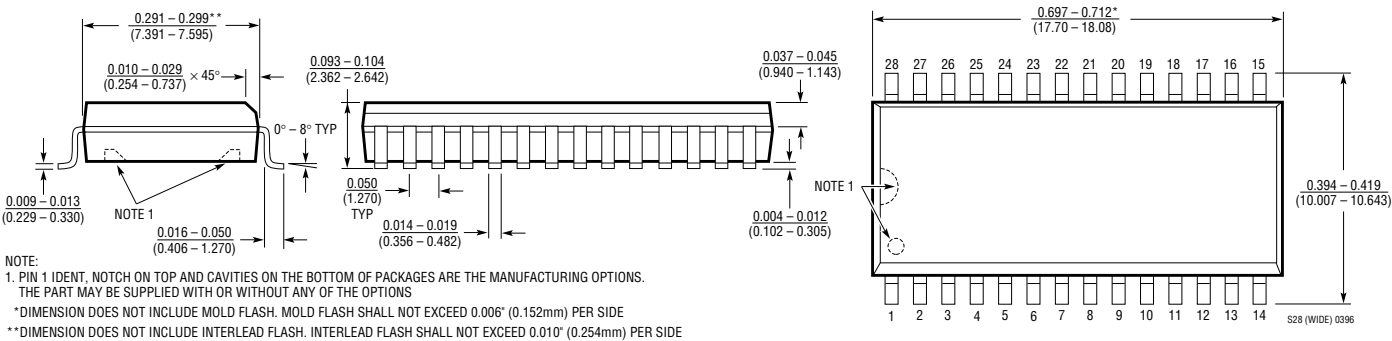
Figure 7. Driver Test Results at 250kbps

PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.

G Package
28-Lead Plastic SSOP (0.209)
(LTC DWG # 05-08-1640)



SW Package
28-Lead Plastic Small Outline (Wide 0.300)
(LTC DWG # 05-08-1620)



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1137A	3-DR/5-RX RS232 Transceiver	±15kV IEC-801-2 ESD Protection
LTC1327	3-DR/5-RX RS562 Transceiver	3.3V Operation
LT1330	3-DR/5-RX RS232	3V Logic Interface
LT1331	3-DR/5-RX RS232/RS562 Transceiver	5V RS232 or 3V RS562 Operation
LTC1347	3-DR/5-RX Micropower RS232 Transceiver	5 Receivers Active in Shutdown